

12A, 400V - 1000V Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Low forward voltage drop
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.270g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE UNI			
I _F	12	Α		
V_{RRM}	400 - 1000	V		
I _{FSM}	300 A			
T_{JMAX}	150	°C		
Package	DO-214AB (SMC)			
Configuration	Single die			





DO-214AB (SMC)



PARAMETER	SYMBOL	\$42GC	642 IC	SASKC	S12MC	HIMIT
PARAMETER	STWIBUL	31260	31230	JIZKU	3121110	ONI
Marking code on the device		S12GC	S12JC	S12KC	S12MC	
Repetitive peak reverse voltage	V_{RRM}	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	560	700	V
Forward current	I _F	12			Α	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	300			А	
Junction temperature	TJ	- 55 to +150			°C	
Storage temperature	T _{STG}	- 55 to +150		°C		





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	9	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	44	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 12A, T _J = 25°C	V _F	-	1.1	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C		-	1	μA
Reverse current @ rated v _R	T _J = 125°C	I _R	-	250	μA
Junction capacitance	$1MHz, V_R = 4.0V$	CJ	78	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾ PACKAGE PACKING			
S12xC	DO-214AB (SMC)	3,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 400V(S12GC) to 1000V(S12MC)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

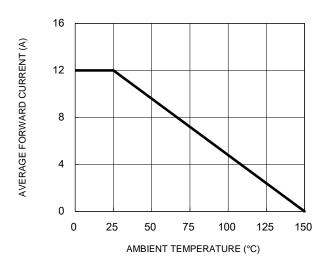


Fig.3 Typical Reverse Characteristics

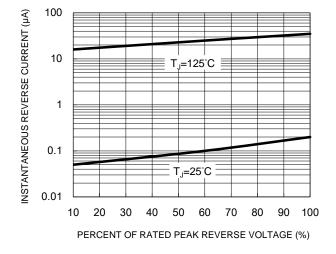


Fig.2 Maximum Non-Repetitive Forward Surge Current

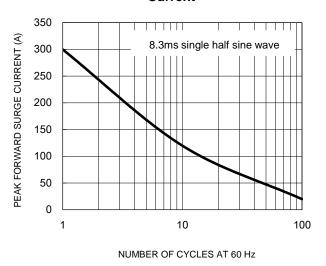
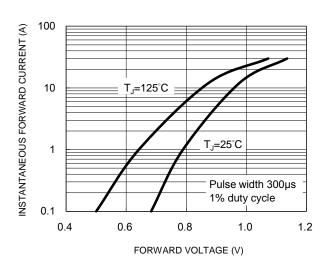


Fig.4 Typical Forward Characteristics

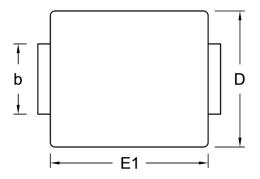


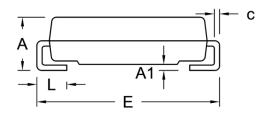




PACKAGE OUTLINE DIMENSIONS

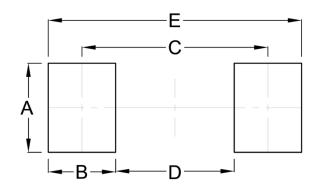
DO-214AB (SMC)





DIM.	Unit (mm)		Unit ((inch)	
Dilvi.	Min.	Max.	Min.	Max.	
Α	2.00	2.62	0.079	0.103	
A1	0.10	0.20	0.004	0.008	
b	2.90	3.20	0.114	0.126	
С	0.15	0.31	0.006	0.012	
D	5.59	6.22	0.220	0.245	
E	7.75	8.13	0.305	0.320	
E1	6.60	7.11	0.260	0.280	
L	1.00	1.60	0.039	0.063	

SUGGESTED PAD LAYOUT



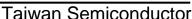
Symbol	Unit (mm)	Unit (inch)
Α	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

ΥW = Date Code F = Factory Code





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